

## COMMISSIONER FOR PATENTS

P.O. Box 1450, Alexandria, VA 22313-1450

Docket No. MEG03-005

Transmitted herewith for filing is the Patent Application of:

Inventor: MOU-SHIUNG LIN, MICHAEL CHEN, CHIEN KANG CHOU, MARK CHOUFor: POST-PASSIVATION METAL SCHEME ON AN IC CHIP WITH COPPER INTERCONNECTION

DUPLICATE

22782 U.S. PTO  
10/796427

Enclosed are:

- ☒ 5 sheets of drawing(s) - formal.
- ☒ An assignment of the invention to **Megic Corporation**
- ☐ An associate power of attorney ☒ Applicant claims small entity status
- ☐ Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 385.
TOTAL CLAIMS	68 -20=	48	x 9 =	\$ 432.
INDEP CLAIMS	12 -3=	9	x 43 =	\$ 387.
			SUB TOTAL	\$ 1,204.
			ASSIGNMENT	\$40.
			TOTAL	\$ 1,244.

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,244. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR §1.16.
- ☒ Any patent application processing fees under 37 CFR §1.17.

Respectfully submitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761

## EXPRESS MAIL CERTIFICATE

Express Mail No. EV385357831US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

3/9/04  
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